

## Automotive P-Channel 60 V (D-S) 175 °C MOSFET

SOT-23 (TO-236)



Top View

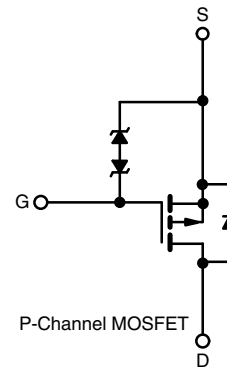
**Marking Code:** 9Vxxx

PRODUCT SUMMARY	
$V_{DS}$ (V)	-60
$R_{DS(on)}$ ( $\Omega$ ) at $V_{GS} = -10$ V	0.170
$R_{DS(on)}$ ( $\Omega$ ) at $V_{GS} = -4.5$ V	0.230
$I_D$ (A)	-2.8
Configuration	Single

### FEATURES

- TrenchFET® power MOSFET
- Typical ESD protection: 800 V
- AEC-Q101 qualified
- 100 %  $R_g$  and UIS tested
- Material categorization:  
for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

 AUTOMOTIVE  
GRADE

**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**


P-Channel MOSFET

ORDERING INFORMATION	
Package	SOT-23
Lead (Pb)-free and halogen-free	SQ2361CEES (for detailed order number please see <a href="http://www.vishay.com/doc?79771">www.vishay.com/doc?79771</a> )

ABSOLUTE MAXIMUM RATINGS ( $T_C = 25$ °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		$V_{DS}$	-60	V
Gate-source voltage		$V_{GS}$	$\pm 20$	
Continuous drain current	$T_C = 25$ °C	$I_D$	-2.8	A
	$T_C = 125$ °C		-1.6	
Continuous source current (diode conduction)		$I_S$	-2.5	
Pulsed drain current <sup>a</sup>		$I_{DM}$	-11	
Single pulse avalanche current	L = 0.1 mH	$I_{AS}$	-13	
Single pulse avalanche energy		$E_{AS}$	8.4	mJ
Maximum power dissipation	$T_C = 25$ °C	$P_D$	2	W
	$T_C = 125$ °C		0.67	
Operating junction and storage temperature range		$T_J, T_{stg}$	-55 to +175	°C

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount <sup>b</sup>	$R_{thJA}$	175	°C/W
Junction-to-foot (drain)		$R_{thJF}$	75	

### Notes

- Pulse test; pulse width  $\leq 300$   $\mu$ s, duty cycle  $\leq 2$  %
- When mounted on 1" square PCB (FR4 material)



SPECIFICATIONS (T <sub>C</sub> = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
<b>Static</b>							
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250 μA		-60	-	-	V
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250 μA		-1.5	-	-2.5	
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 20 V		-	-	± 30	mA
		V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 8 V		-	-	± 2	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = -60 V	-	-	-1	μA
		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = -60 V, T <sub>J</sub> = 125 °C	-	-	-50	
		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = -60 V, T <sub>J</sub> = 175 °C	-	-	-150	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = -10 V	V <sub>DS</sub> ≤ -5 V	-10	-	-	A
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10 V	I <sub>D</sub> = -2.4 A	-	0.130	0.170	Ω
		V <sub>GS</sub> = -10 V	I <sub>D</sub> = -2.4 A, T <sub>J</sub> = 125 °C	-	-	0.300	
		V <sub>GS</sub> = -10 V	I <sub>D</sub> = -2.4 A, T <sub>J</sub> = 175 °C	-	-	0.315	
		V <sub>GS</sub> = -4.5 V	I <sub>D</sub> = -1.8 A	-	0.180	0.230	
Forward transconductance <sup>b</sup>	g <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -2 A		-	5	-	S
<b>Dynamic <sup>b</sup></b>							
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = -30 V, f = 1 MHz	-	415	620	pF
Output capacitance	C <sub>oss</sub>			-	55	80	
Reverse transfer capacitance	C <sub>rss</sub>			-	32	45	
Total gate charge <sup>c</sup>	Q <sub>g</sub>	V <sub>GS</sub> = -10 V	V <sub>DS</sub> = -30 V, I <sub>D</sub> = -6 A	-	10	15	nC
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>			-	1.5	-	
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>			-	5	-	
Gate resistance	R <sub>g</sub>	f = 1 MHz		2.15	4.3	6.45	Ω
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>	V <sub>DD</sub> = -30 V, R <sub>L</sub> = 20 Ω I <sub>D</sub> ≅ -1.5 A, V <sub>GEN</sub> = -10 V, R <sub>g</sub> = 1 Ω		-	9	12	ns
Rise time <sup>c</sup>	t <sub>r</sub>			-	9	12	
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>			-	24	30	
Fall time <sup>c</sup>	t <sub>f</sub>			-	4	6	
<b>Source-Drain Diode Ratings and Characteristics <sup>b</sup></b>							
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	-11	A
Forward voltage	V <sub>SD</sub>	I <sub>F</sub> = -1.5 A, V <sub>GS</sub> = 0 V		-	-0.8	-1.2	V
Body diode reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = -1.5 A, di/dt = 100 A/μs		-	23	46	ns
Body diode reverse recovery charge	Q <sub>rr</sub>			-	25	50	nC
Reverse recovery fall time	t <sub>a</sub>			-	20	-	ns
Reverse recovery rise time	t <sub>b</sub>			-	3	-	
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	-2.9	-	A

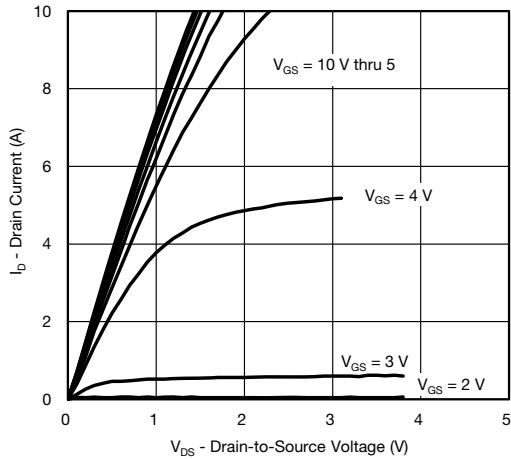
**Notes**

- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

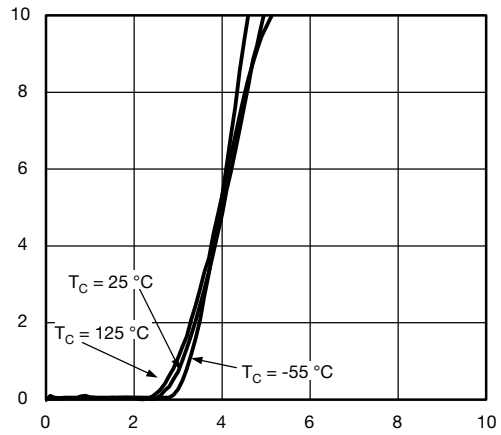
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



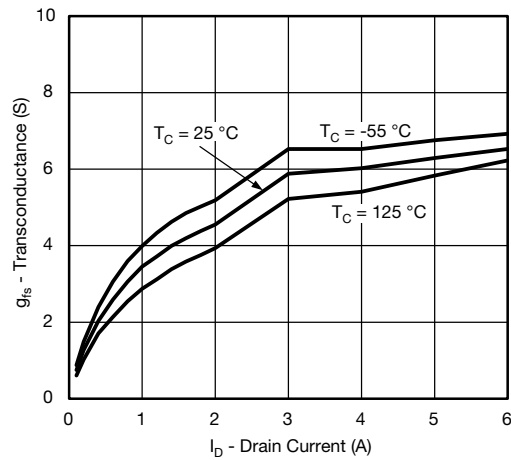
**TYPICAL CHARACTERISTICS** ( $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise noted)



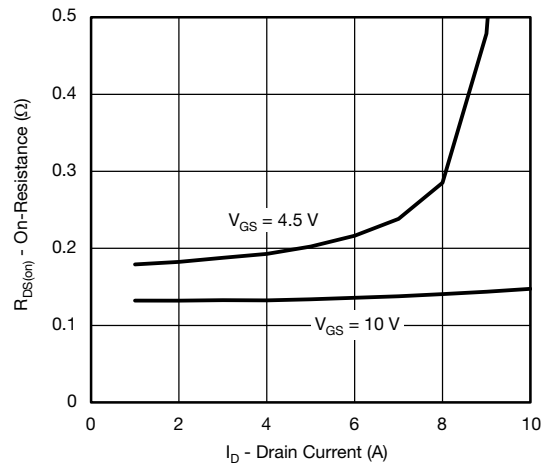
**Output Characteristics**



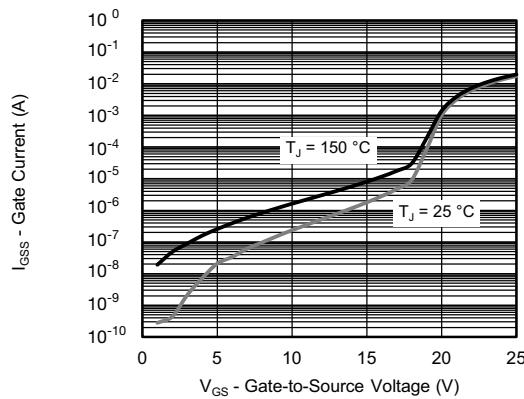
**Transfer Characteristics**



**Transconductance**



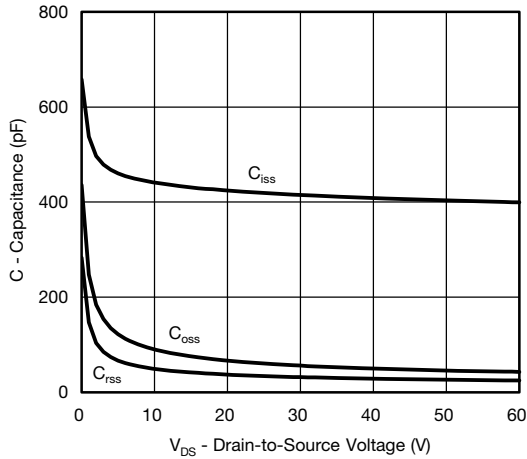
**On-Resistance vs. Drain Current**



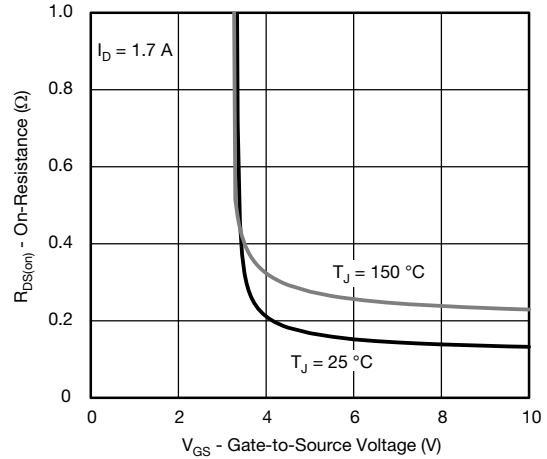
**Gate Current vs. Gate-Source Voltage**



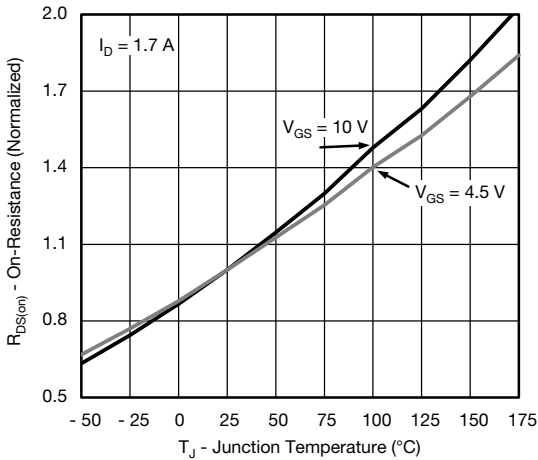
TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise noted)



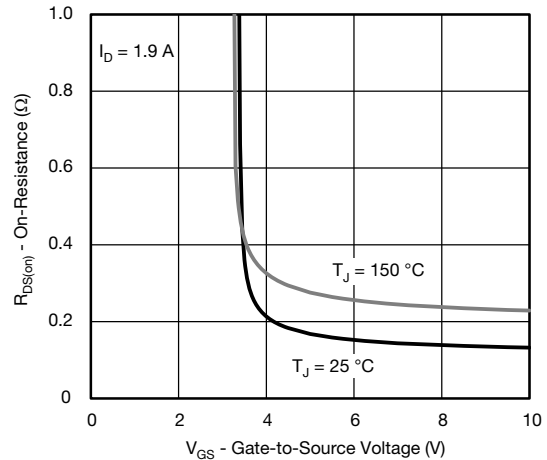
Capacitance



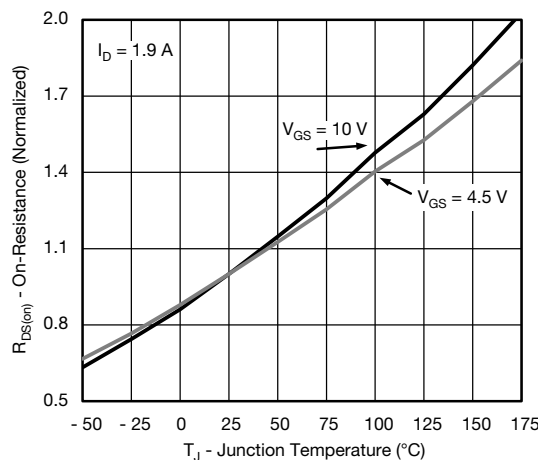
On-Resistance vs. Gate-Source Voltage



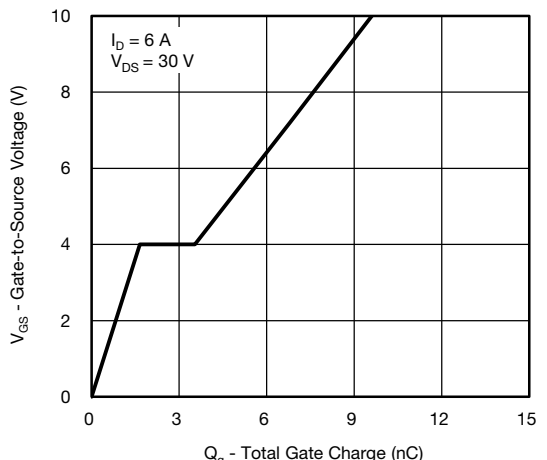
On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-Source Voltage



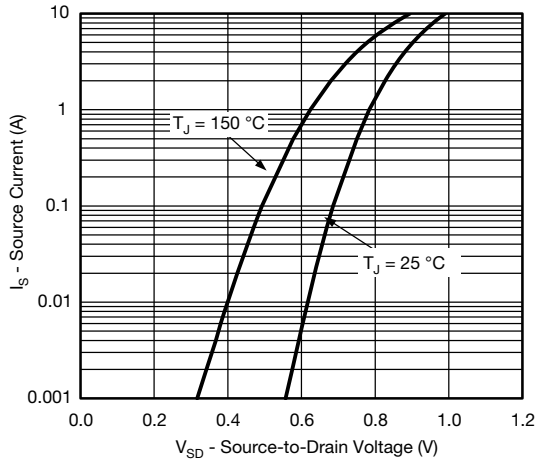
On-Resistance vs. Junction Temperature



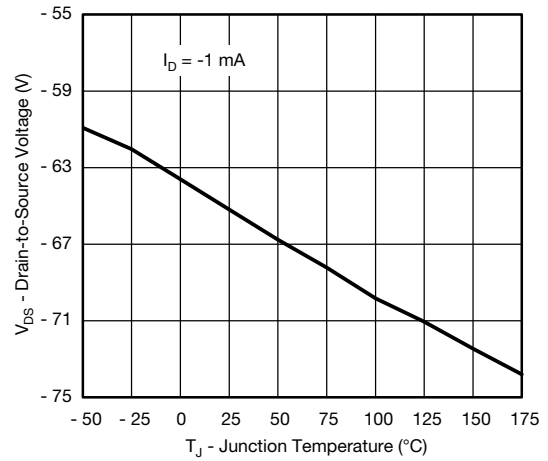
Gate Charge



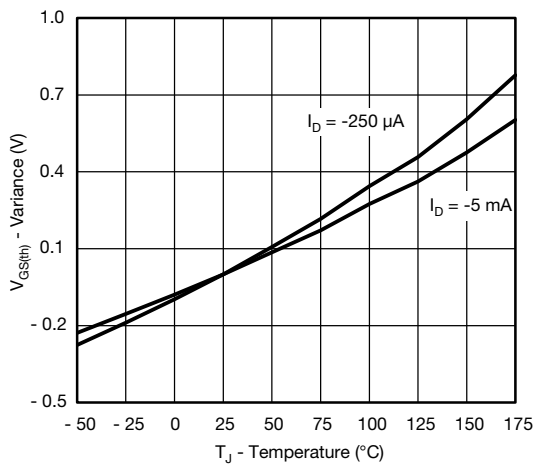
TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise noted)



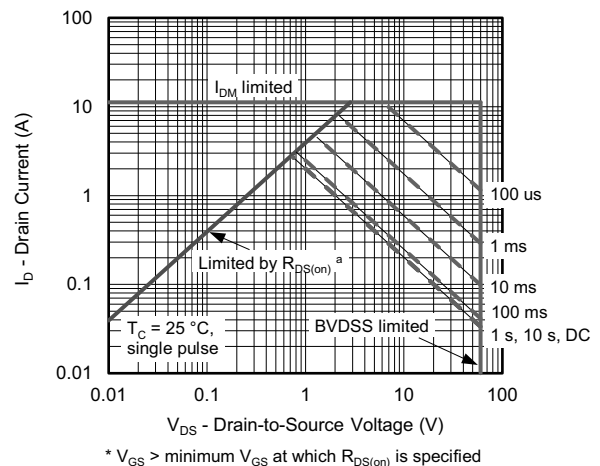
Source-Drain Diode Forward Voltage



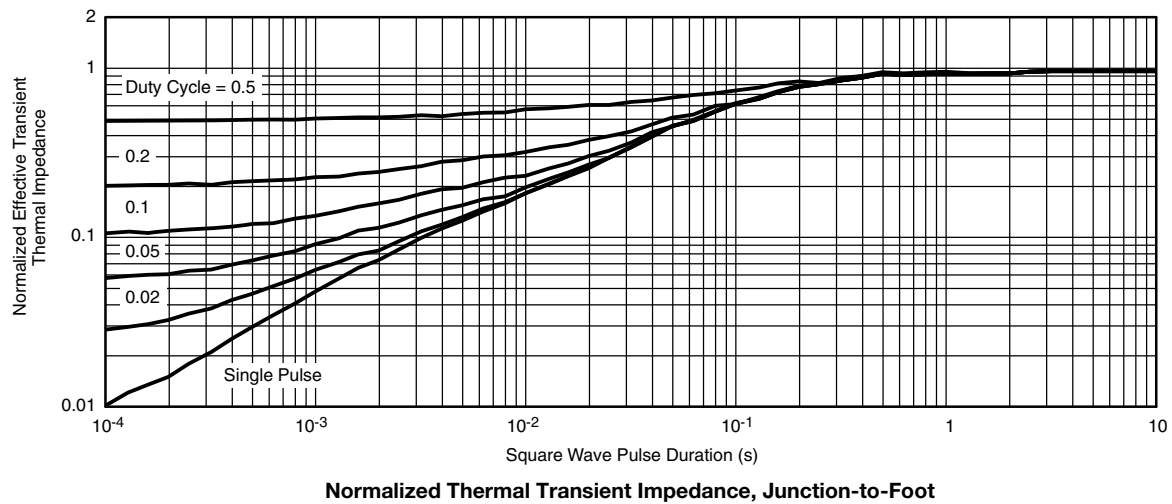
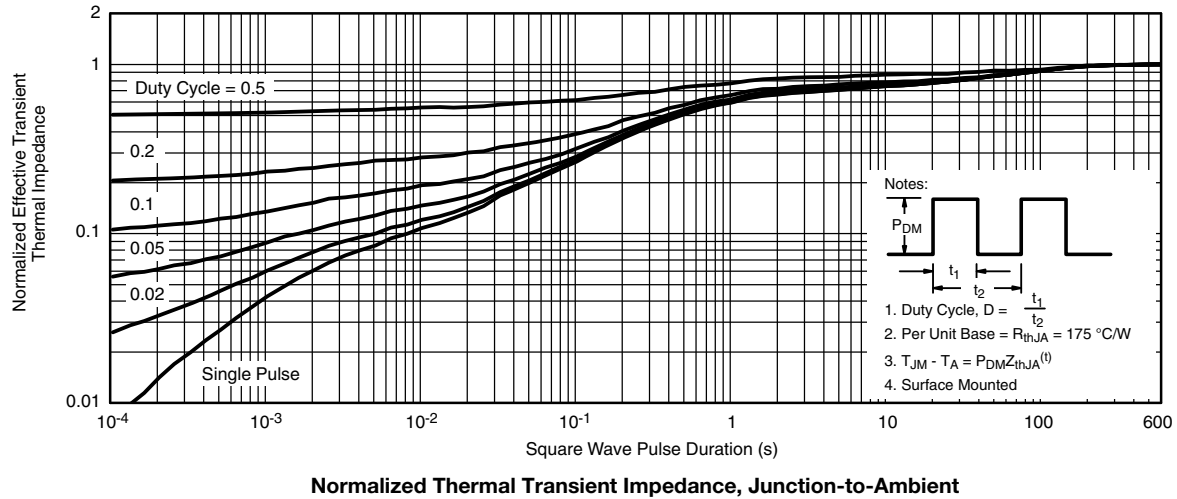
Drain Source Breakdown vs. Junction Temperature



Threshold Voltage



Safe Operating Area

**THERMAL RATINGS** ( $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise noted)

**Note**

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient ( $25\text{ }^\circ\text{C}$ )
  - Normalized Transient Thermal Impedance Junction-to-Foot ( $25\text{ }^\circ\text{C}$ )
 are given for general guidelines only to enable the user to get a “ball park” indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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